Exhibitor Guidelines

Application Method

Please fax the "Application Form" after filling in all required items.

1. Application Deadline: September 29, 2017

* However, if all spaces are reserved prior to the deadline, the application will no longer be accepted, so please

2. Exhibition Fee Payment: An invoice will be sent after receiving the official application.

*Please make a bank transfer of the exhibition fee to the indicated bank account by the date indicated on the

3. Application Cancellation: As a general rule, cancellation may not be made after submitting the application form.

*However, if the executive office determines cancellation is unavoidable, cancellation shall be accepted upon payment of the cancellation fees listed in the chart to the right.

Space and Exhibition Fee

 $(1 \text{ space} = 3m \times 3m)$

Corporate	320,000 JPY (tax not included) per space
Public Institution, University Laboratory	160,000 JPY (tax not included) per space

^{*} Booth locations shall be chosen by the organizer based on date of application, number of spaces, and past participation

Package Booth Plan Guide

One Booth Package Plan

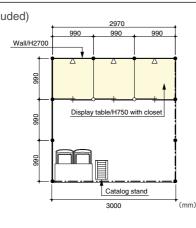
* There are two and three booths package plans.

From Aug.1 to Sep. 29, 2017

50% of Invoice Fee

100% of Invoice Fee





One pacakge booth includes

Display table (W990mm×D990mm×H750mm)	3
Reception counter (W900mm×D450mm×H750mm)	1
Parapet (H300mm)	3m
Company name plate (W1200mm×H200mm)	1
Folding chair	2
Catalog stand (A4 paper size 12 tiers)	1
Business card box	1
Spot light (100W)	3
Floor carpet	9m²
Power (including electricity fee)	1kW
Outlet (2 plugs)	1
Trash can	1

Pre-exhibition Schedule

July 2017	August	September	October	November	December	February 2018
		September 29 Application Deadline	October 31 Payment Deadline The end o Exhibitor	f October	Early December Document Submission Deadline	Feb. 12-13, 2018 Delivery/Setup Feb. 14-16, 2018 10:00 ~ 17:00 Exhibition dates

Future Exhibition Schedule

	Convertech JAPAN	neo functional material	Printable Electronics	🎄 3Decotech Expo	Advanced Printing Technology Exhibition	Prototype and Contracted Manufacturing Exhibition
Feb. 15-17, 2017	0	0	0	0	0	0
Feb. 14-16, 2018	-	Materials zone Neo functional paper zone Prototyping / Contracting zone Machinery zone	0	0	-	Included in neo functional material
Jan. 30-Feb.1, 2019	0	0	0	0	0	Included in neo functional material

About applying for exhibition, please contact to

Converting Technical Institute

6F, 3-4-6, Iwamoto-cho, Chiyoda-ku, Tokyo 101-0032 TEL:+81-3-3861-3858 FAX:+81-3-3861-3894 E-mail: con@ctiweb.co.jp

About exhibition operation, please contact to

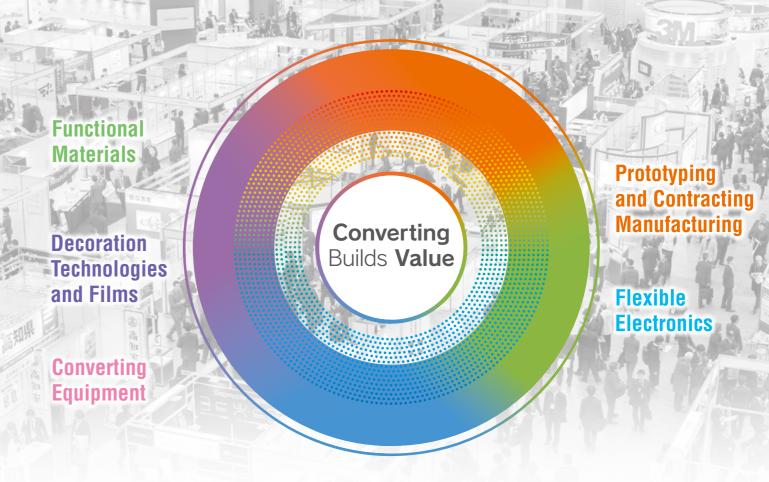
JTB Communication Design, Inc.

Celestine Shiba Mitsui Bldg., 3-23-1, Shiba, Minato-ku,

Tokyo 105-8335, Japan

TEL:+81-3-5657-0761 FAX:+81-3-5657-0645

E-mail: kinousei@jtbcom.co.jp printable@jtbcom.co.jp convertech@jtbcom.co.jp



Converting Technology Exhibition



Materials zone

Neo functional paper zone

Prototyping / Contracting zone

Printable Electronics 2018



3Decotech Expo2018

Exhibition Guide

 $2.14 \text{ (Wed.)} \sim 16 \text{ (Fri.)} 2018$ Tokyo Big Sight, East Hall

Organizer: Converting Technical Institute

Co-organizer: JTB Communication Design, Inc. convertech



Converting Technology Exhibition

Date	February 14 (Wed.) - 16 (Fri.), 201	8
	10·00 - 17·00	

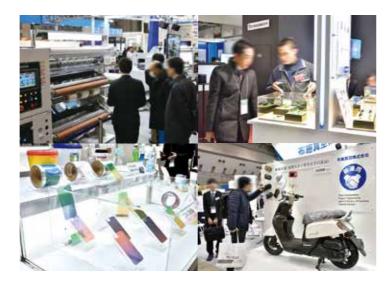
Tokyo Big Sight East Hall 2-3 Venue

Converting Technical Institute Organizer

Co-organizer JTB Communication Design, Inc.

200 Companies / 400 booths (expected) Exhibitors

Visitors **50.000** (including concurrent events)





















Business Partner Search/New Business Creation/Market Trends





















Meeting the needs of the times,

the Converting Technology Exhibition serves as a location to create "Value" and aims to contribute to an industrial revolution for the future of manufacturing.

Electronics Energy Medical / Nursing Packaging Agriculture / Food **Education Textile etc.**

Visitors

Converting Technology Exhibition





Prototyping and Contracting Technologies

Exhibitors

Exhibit Categories



Materials zone Neo functional paper zone

New Value Generating Functional Materials

Materials zone

Functional Materials: coatings/paints/inks, adhesives, PSA/release agents, anchor coatings, emulsions/ microcapsules, substrate films, metal foils, glass/inorganic polymers, composite materials, etc.

Functional Resins/Additives: synthetic resins/engineering plastics, elastomer, antistatic reagents, nano materials (CNT, graphene, etc.), thermal management materials (heat radiation/conduction), curing reagents, surfactants, defoamers, dispersants, inhibitors, polymerization initiators, modifiers, pigments, master batches, battery materials, etc.

Functional Films: optical films, electrical films, photovoltaic films/battery films/fuel cell films, high-barrier films, heat resistant films, hard films, transparent conductive films, automotive/industrial films, packaging films, medical films, architectural films, sign printing films, etc.

Neo functional paper zone

functional paper, paper/special paper, pulp/raw fiber/paper making materials, paper making chemicals, nonwoven fabric, functional fibers/fiber sheets/compound materials, filters, separators, cellulose/ cellulose nanofiber, biomass resources/materials, paper making machinery/pulp machinery/coaters/ nonwoven fabric production machines/pulverizers, paper making technology/paper converting technology/secondary converting technology, etc.

Contracting zone

Contracted Manufacturing: coating, adhesives, lamination, coating technology, surface treatment, slitting/cutting/die-cutting/punching, knurling/embossing, surface treatment, polishing, polymerization, formulation/synthesis, compounding, dispersion, grinding, contracted manufacturing, film forming, etc.

Services: research, analysis, measuring, prototyping, pilot production, OEM, R&D support (test sample production, etc.), consulting, etc.

Machinery zone

coater, vacuum film deposition devices, laminators, printing machines, slitters, rewinders, film forming devices and related equipment, inspection equipment, control systems, rollers, web handling devices, static and dust removal equipment, blades, testing/measuring/analysis equipment, pulverizers/mixers, other peripheral equipment

Printable Electronics 2018

Aiming to Realize a World of IoT Through Printed & Flexible Electronics

Process Technology/Equipment: inkjet, screen printing, gravure offset printing, imprinting, transfer printing, 3D printing, UV printing, sputtering, micro-patterning exposure equipment, laser ablation, drying-curing-sintering equipment, etc.

Materials: metal inks, nano-metal inks, conductive wiring, conductive polymers, insulation inks, heat-resistant films, substrates, etc.

Devices: flexible devices, organic TFT, OLED, electronic paper, measuring-evaluation-analysis equipment, microscopes, etc.

3Decotech Expo2018

Specialized in the Decoration Technologies that Create New Value through the Fusion of Ornamentation and Function

Decorative Film/Transfer Foil: in-mold lamination film, in-mold transfer film, overlay transfer film, overlay lamination film, water transfer film, deposition film, transfer foil, hologram film, etc.

Decorative/Transfer Equipment: 3D decorative molding technology, insert molding, in-mold lamination, in-mold decoration, surface decoration technology, trimming equipment, die-molds, etc.

Converting Technology: decoration, molding, graining, hair lining, sandblasting, heat & cool molding, decorative plating, coating, gloss application, finishing technologies, design, etc.